# Power MOSFET, Automotive N-Channel, SUPERFET® III, Easy-drive

**650 V, 44 A, 72 m**Ω

#### **Description**

SuperFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss provide superior switching performance, and withstand extreme dv/dt rate. Consequently, SuperFET III MOSFET Easy-drive series helps manage EMI issues and allows for easier design implementation.

#### **Features**

- AEC-Q101 Qualified
- Max Junction Temperature 150°C
- Typ.  $R_{DS}(on) = 61 \text{ m}\Omega$
- Ultra Low Gate Charge (Typ. Q<sub>G</sub> = 82 nC)
- Low Effective Output Capacitance (Typ. C<sub>OSS</sub>(eff.) = 724 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

#### **Typical Applications**

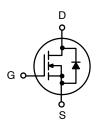
- Automotive PHEV-BEV DC-DC Converter
- Automotive Onboard Charger for PHEV-BEV



#### ON Semiconductor®

#### www.onsemi.com

BV <sub>DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
650 V	72 m $\Omega$ @ $10$ V	44 A

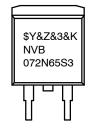


**N-Channel MOSFET** 



D2PAK 3 LEAD CASE 418AJ

#### **MARKING DIAGRAM**



\$Y = ON Semiconductor Logo &Z = Assembly Plant Code

= Numeric Date Code

&K = Lot Code

&3

NVB072N65S3 = Specific Device Code

#### ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise specified)

Symbol		Value	Unit	
V <sub>DSS</sub>	Drain to Source Voltage	Orain to Source Voltage		V
V <sub>GSS</sub>	Gate to Source Voltage	DC	±30	V
		AC (f > 1 Hz)	±30	V
I <sub>D</sub>	Drain Current	Continuous (T <sub>C</sub> = 25°C)	44	Α
		Continuous (T <sub>C</sub> = 100°C)	28	Α
I <sub>DM</sub>	Pulsed Drain Current	Pulsed (Note 1)	110	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		214	mJ
E <sub>AR</sub>	Repetitive Avalanche (Note 1)		3.12	mJ
dv/dt	MOSFET dv/dt Peak Diode Recovery dv/dt (Note 3)		100	V/ns
			20	V/ns
$P_{D}$	Power Dissipation	(T <sub>C</sub> = 25°C)	312	W
		Derate Above 25°C	2.5	W/°C
T <sub>J</sub> ,T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: pulse–width limited by maximum junction temperature.

2. I<sub>AS</sub> = 4.8 A, R<sub>G</sub> = 25 Ω, starting T<sub>J</sub> = 25°C.

3. I<sub>SD</sub> < 44 A, di/dt ≤ 200 A/ms, VDD ≤ BVDSS, starting T<sub>J</sub> = 25°C.

- 4. Essentially independent of operating temperature typical characteristics.

#### THERMAL CHARACTERISTICS

Symbol	Parameter		Unit
$R_{ heta JC}$	Thermal Resistance, Junction to Case, Max.	0.37	°C/W
$R_{ heta JA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (1 in <sup>2</sup> Pad of 2-oz Copper), Max.	40	°C/W

#### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Marking	Package	Packing Method	Shipping (Qty / Packing)
NVB072N65S3	NVB072N65S3	D <sup>2</sup> PAK-3	Tube	30 Units / Tube

### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARACT	ERISTICS					
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C	650	-	-	V
		V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 150°C	700	-	-	V
ΔBVDSS / ΔTJ	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 1 mA, Referenced to 25°C	-	0.60	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V	_	0.30	1	μΑ
		V <sub>DS</sub> = 520 V, V <sub>GS</sub> = 0 V, Tc = 125°C	-	7.30	-	
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>GS</sub> = ±30 V, V <sub>DS</sub> = 0 V	-	-	±100	nA
N CHARACTE	RISTICS					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1.0 \text{ mA}$	2.5	_	4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A, T <sub>J</sub> = 25°C	-	61	72	mΩ
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 22 A, T <sub>J</sub> = 100°C	-	107	-	mΩ
9FS	Forward Transconductance	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 44 A	-	29.7	-	S
YNAMIC CHAI	RACTERISTICS		•	•		
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	3300	_	pF
C <sub>oss</sub>	Output Capacitance		-	72.8	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	14.6	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V	-	724	-	pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	V <sub>DS</sub> = 0 V to 400 V, V <sub>GS</sub> = 0 V	_	104	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 44 A	_	82.0	_	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	(Note 4)	_	23.3	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		_	34.0	_	nC
R <sub>G</sub>	Gate Resistance	f = 1 MHz	-	0.685	-	mΩ
WITCHING CH	ARACTERISTICS		•	•		
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 44 A, V <sub>GS</sub> = 10 V,	-	26.3	-	ns
t <sub>r</sub>	Turn-On Rise Time	$R_G = 4.7 \Omega$ (Note 4)	_	50	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		_	65.9	-	ns
t <sub>f</sub>	Fall Time		_	32	-	ns
	E DIODE CHARACTERISTICS		•	•		
I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		_	_	44	Α
I <sub>SM</sub>	Maximum Plused Drain to Source Diode Forward Current		_	-	110	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 22 A	-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 44 A dI <sub>F</sub> /dt = 100 A/μs	_	576	-	nS
Q <sub>rr</sub>	Reverse Recovery Charge	1	_	14.3	_	μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL CHARACTERISTICS**

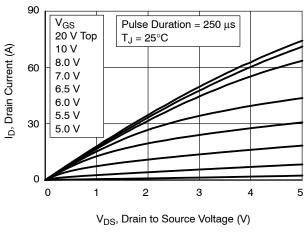


Figure 1. Saturation Characteristics

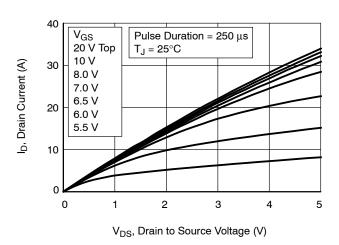


Figure 2. Saturation Characteristics

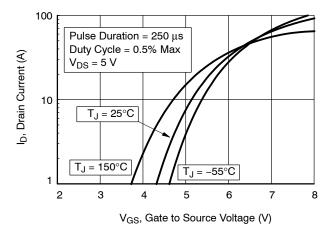


Figure 3. Transfer Characteristic

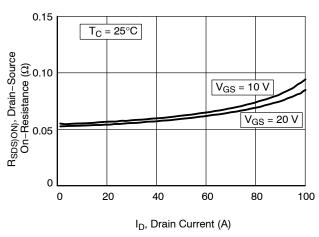


Figure 4. On-Resistance Variation vs. Drain Current and Gate Voltage

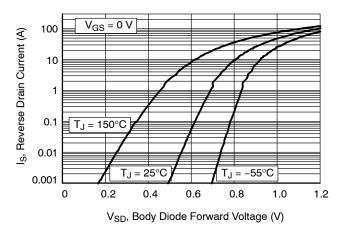


Figure 5. Forward Diode Characteristics

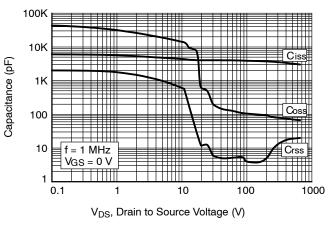


Figure 6. Capacitance vs. Drain to Source Volatage

#### TYPICAL CHARACTERISTICS (continued)

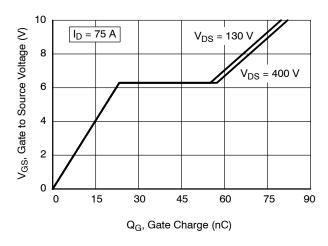


Figure 7. Gate Charge vs. Gate to Source Voltage

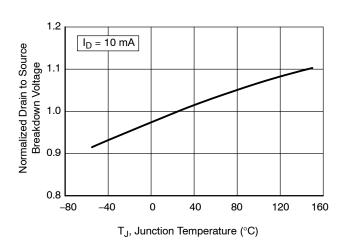


Figure 8. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

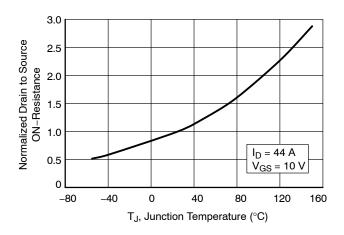


Figure 9. Normalized R<sub>DSON</sub> vs. Junction Temperature

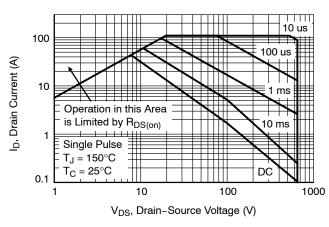


Figure 10. Forward Bias Safe Operating Area

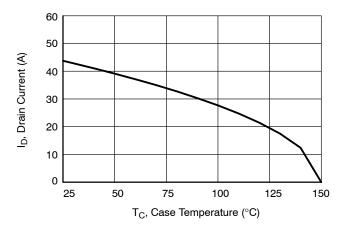


Figure 11. Maximum Continuous Drain Current vs. Case Temperature

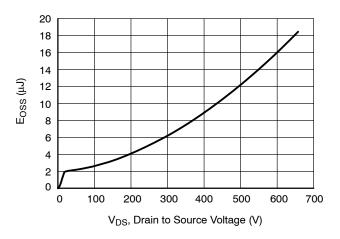
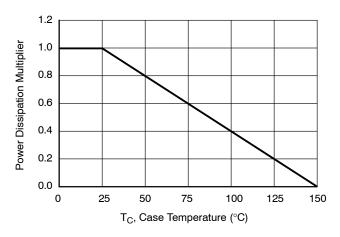


Figure 12. E<sub>OSS</sub> vs. Drain to Source Voltage

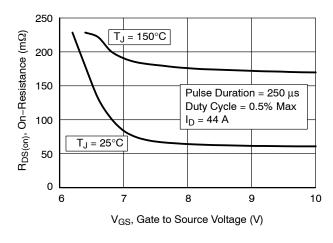
#### TYPICAL CHARACTERISTICS (continued)



1000 (V) tues 100 (V) 100 (V)

Figure 13. Normalized Power Dissipation vs. Case Temperature

Figure 14. Peak Current Capability



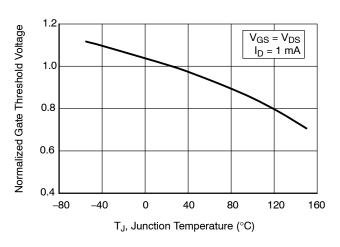


Figure 15. On-Resistance vs. Gate to Source Voltage

Figure 16. Normalized Gate Threshold Voltage vs. Temperature

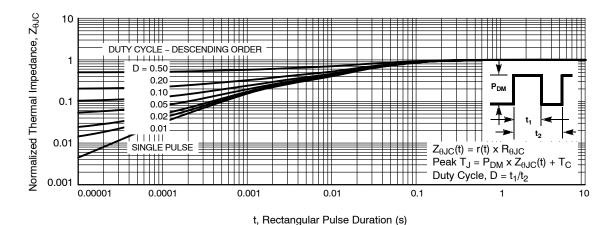
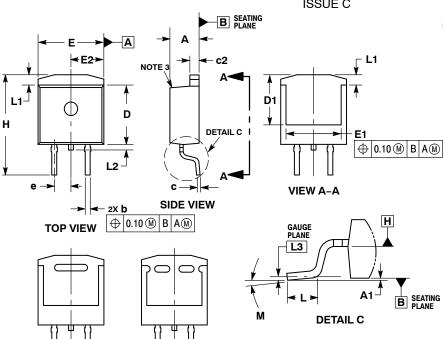


Figure 17. Normalized Maximum Transient Thermal Impedance

#### PACKAGE DIMENSIONS

# D<sup>2</sup>PAK-3 (TO-263, 3-LEAD) CASE 418AJ ISSUE C



VIEW A-A
OPTIONAL CONSTRUCTIONS

- NOTES:

  1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

  2. CONTROLLING DIMENSION: INCHES.

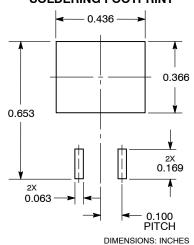
  3. CHAMFER OPTIONAL

  4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.005 PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.

  5. THERMAL PAD CONTOUR IS OPTIONAL WITHIN DIMENSIONS E, L1, D1 AND E1.

	INCHES		MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.160	0.190	4.06	4.83	
<b>A</b> 1	0.000	0.010	0.00	0.25	
q	0.020	0.039	0.51	0.99	
C	0.012	0.029	0.30	0.74	
c2	0.045	0.065	1.14	1.65	
D	0.330	0.380	8.38	9.65	
D1	0.260		6.60		
Е	0.380	0.420	9.65	10.67	
E1	0.245		6.22		
е	0.100 BSC		2.54 BSC		
Н	0.575	0.625	14.60	15.88	
L	0.070	0.110	1.78	2.79	
L1		0.066		1.68	
L2		0.070		1.78	
L3	0.010 BSC		0.25 BSC		
М	-8°	8°	-8°	8°	

#### **RECOMMENDED SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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